

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5714175

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MAREK STEFFANSON	12/17/2018
GABRIELLE DE WIT	12/17/2018
DONALD JAMES BONE	12/18/2018
MARK HALSTEAD	12/17/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MP HIGH TECH SOLUTIONS PTY LTD
<b>Street Address:</b>	SUITE 145
<b>Internal Address:</b>	4 CORNWALLIS STREET
<b>City:</b>	EVELEIGH, NSW
<b>State/Country:</b>	AUSTRALIA
<b>Postal Code:</b>	2015
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16222961
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(415)707-2010
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	16503288500
<b>Email:</b>	Wardadm@gtlaw.com
<b>Correspondent Name:</b>	EMA MAJIC
<b>Address Line 1:</b>	GREENBERG TRAURIG, LLP
<b>Address Line 2:</b>	77 WEST WACKER DRIVE, SUITE 3100
<b>Address Line 4:</b>	CHICAGO, ILLINOIS 60601
<b>ATTORNEY DOCKET NUMBER:</b>	152763-201201/US
<b>NAME OF SUBMITTER:</b>	EMA MAJIC
<b>SIGNATURE:</b>	/Ema Majic/
<b>DATE SIGNED:</b>	09/11/2019
<b>Total Attachments: 4</b>	

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source=152763-201201\_16222961\_Assignment#page4.tif

**COMBINED PATENT ASSIGNMENT AND DECLARATION**

As the below named inventor of an invention entitled,

**APPARATUS AND METHOD TO ADJUST SENSITIVITY IN MEASURING ELECTROMAGNETIC  
RADIATION USING MICRO MIRRORS**

I HEREBY DECLARE that:

This declaration is directed to

- ☒ the attached application, or  
☐ United States Patent Application Serial Number \_ filed on \_.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I HEREBY ACKNOWLEDGE that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.


I HEREBY STATE that I have reviewed and understand the contents of the above-identified application, including the claims; and I am aware of the duty to disclose to the U.S. Patent and Trademark Office all information known by me to be material to patentability as defined in 37 CFR §1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT International filing date of the continuation-in-part application.

TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign and transfer to

MP High Tech Solutions Pty Ltd, a corporation organized and existing under the laws of Australia, and having a mailing address of Suite 145, 4 Cornwallis Street, Eveleigh, NSW, 2015, AU (hereinafter referred to as ASSIGNEE), which is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefore in the United States and in any and all foreign countries

the full and exclusive right, title and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said invention by said application or any nonprovisional, continuation, continuation-in-part, divisional, renewal, substitute or reissue thereof or any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

I HEREBY COVENANT that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

<b>Legal Name of Inventor</b>	<b>Last Name</b> Steffanson	<b>First Name</b> Marek	<b>Middle Name</b>
<b>Residence &amp; Citizenship</b>	<b>City &amp; State/Region</b> Mosman	<b>Country</b> AU	<b>Country of Citizenship</b> AT
<b>Mailing Address</b>	<b>Street</b> Suite 145, 4 Cornwallis St	<b>City &amp; State/Region</b> Eveleigh, NSW	<b>Postal Code &amp; Country</b> 2015, AU
<b>Signature of Inventor:</b> 			<b>Date:</b> 17 Dec 2018

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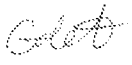
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<b>Legal Name of Inventor</b>	<b>Last Name</b> de Wit	<b>First Name</b> Gabrielle	<b>Middle Name</b>
<b>Residence &amp; Citizenship</b>	<b>City &amp; State/Region</b> Pymble	<b>Country</b> AU	<b>Country of Citizenship</b> AU
<b>Mailing Address</b>	<b>Street</b> 21 Selwyn St	<b>City &amp; State/Region</b> Pymble, NSW	<b>Postal Code &amp; Country</b> 2073, AU
<b>Signature of Inventor:</b> 			<b>Date:</b> 17/12/2018

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<b>Legal Name of Inventor</b>	<b>Last Name</b> Bone	<b>First Name</b> Donald	<b>Middle Name</b> James
<b>Residence &amp; Citizenship</b>	<b>City &amp; State/Region</b> Wentworth Falls	<b>Country</b> AU	<b>Country of Citizenship</b> AU
<b>Mailing Address</b>	<b>Street</b> 4 Wood St	<b>City &amp; State/Region</b> Wentworth Falls, NSW	<b>Postal Code &amp; Country</b> 2782, AU
<b>Signature of Inventor:</b> 		<b>Date:</b> 18/12/2018	

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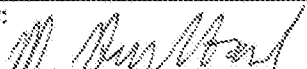
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<b>Legal Name of Inventor</b>	<b>Last Name</b> Halstead	<b>First Name</b> Mark	<b>Middle Name</b>
<b>Residence &amp; Citizenship</b>	<b>City &amp; State/Region</b> Auckland	<b>Country</b> NZ	<b>Country of Citizenship</b> NZ
<b>Mailing Address</b>	<b>Street</b> 3A Allenby Ave	<b>City &amp; State/Region</b> Auckland	<b>Postal Code &amp; Country</b> 0624, NZ
<b>Signature of Inventor:</b> 			<b>Date:</b> 12/17/2016